

标准&定制开关连接器产品制造商

DONG GUAN XI BANG ELECTRONICS CO., LTD.

规 格 书 SPECIFICATION

CUSTOMER NAMI	客户名称:						
CUSTOMER NO.	客户编号:						
SERIES	AIES 系列:		弹片式电池座连接器				
MODEL NO.	型	号:					
DRAWING NO.	图形	号:	Spri	ng type battery s	ocket connector		
If specification of this product meets your request, please confirm all the items of it and return to us with signature and stamp, it will be basis of our production and record. Thanks your cooperation in advance! 若此产品规格符合贵司要求,敬请确认此规格书内所有项目 并签名和盖章后回传给我司,以作我司产品制作之 依据和存档之用,多谢合作!							
	EXA			PROVAL 审批			
APPROVE 接受				NOT APPROVE 不	· 按 码		
SIGNATURE 签署 STAME	P盖章 D _L	ATE日期		NOT AFFROVE /J	·按文		
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溪榜(香港)有限公司

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Quality core! Afterburner for Made in China!

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規 格 書 SPECIFICATION

SERIES系列: CONNECTERMODEL NO.型號: 电池座系列1. RATING額定值: 3A 12V DC

CIRCUIT 回路:
 TIMING 切換類型:

4. STANDARD TEST TEMPERATURE SHALL BE 5°C TO 35°C AND HUMIDITY SHALL BE 45% TO 85% .

溫度 5~35℃, 濕度 45~85% 標準狀態下測試。

5. OPERATING TEMPERATURE RANGE IS -20°C TO 70°C. IT IS USUALLY APPLIED TO ELECTRONIC AND ELECTRICAL APPLIANCE PRODUCTS.

溫度 -20℃~70℃ 環境內使用。一般適用於電子、電氣方面產品使用。

6. STORAGE TEMPERATURE RANGE: -40℃~85℃. 保存溫度範圍-40℃~85℃.

ITEM 項目		TEST CONDITION 測試條件	PERFORMANCE 性能			
	7. ELECTRONICAL PERFORMANCE 電氣性能					
7. 1	CONTACT RESISTANCE 接觸電阻	Being tested at 1 kHz small current and voltage (100mA,20mV) by contact resistance meter. 在 1kHz 小電流電壓(100mA,20mV)下測量。	20mΩ max. 20毫歐 以下。			
7. 2	INSULATION RESISTANCE 絕緣電阻	DC 500 V shall be applied for test between terminals and between terminals and frame for one minute. 在端子之間和端子與殼之間加 DC 500 V 條件下,持續1分鐘測量。	100 M Ω min. 100兆歐 以上。			
7. 3	WITHSTAND VOLTAGE 耐電壓	AC 500 V and induction current 1 mA shall be applied for test between terminals and between terminals and frame for one minute. 在端子之間和端子與殼之間加 AC 500 V (50Hz或60Hz) 感應電流 1mA 條件下,持續1分鐘測量。	There shall be no breakdown. 無擊穿現象出現。			
	8. MECHANICAL PERFORMANCE 機械性能					
8. 1	OPERATING FORCE 操作力度	Push the top of spring plate,the travel is0.5mm to1.0mm 彈片頂部下壓行程0.5至1.0mm	force: 600gf max			

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	TEM TEM	TEGT COMPUTION AREA II	DEDECOMA ENGE MA 44.						
ITEM 項目		TEST CONDITION 測試條件	PERFORMAENCE 性能						
8. 2	TERMINAL STRENGTH 端子強度	A static force of 500 g being applied in one direction on the tip of the terminal for l minute. 一個 500 克之靜負荷施加於端子頂部的一個 方向持續1分鐘。	There shall be no sign of mechanical and electrical damage. 無任何跡象顯示機械及電器性能之損壞。						
9. DURABILITY 耐久性									
9.1	SOLDERING TEST 可焊性試驗	The tip of the terminals shall be dipped 2 mm in the solder bath within temperature of 250±5℃ for 3 seconds. 端子頂部被浸入焊錫池 2mm 深,溫度250±5℃,時間3秒。 The condition mentioned is temperature for lead-free soldering.無鉛錫測試 Alloy:Sn 96.5% Cu 3% Ag 0.5% 成份: 錫 96.5% 銅 3% 銀 0.5%	Over 95% of the immersed surface was covered by tin. 浸入的部份95%以上表面將被錫覆蓋。						
9.2	SOLDERING RESISTANT TEST 耐焊性試驗	Manual soldering temperature 350±5°C, soldering time 3±0.5 seconds,however excessive pressure shall not be applied to the terminal. 手焊接的時候溫度需控制在350±5°C,時間爲3±0.5秒,但不能在端子上施加異常壓力。 The condition mentioned is temperature for lead-free soldering. 無鉛錫測試。 Alloy:Sn 96.5% Cu 3% Ag 0.5% 成份: 錫 96.5% 銅 3% 銀 0.5%	Without deformation of case or excessive looseness of teminals, meet mechanical and electrical properties. 本體無變形,能滿足於機械、電器性能.						
9.3	REFLOW SOLDERING HEAT TEST 回流焊接熱試驗	Temperature (°C) 180°C 230°C 230°C Time 2±0. 3min (pre-heating) 3 to 4min. time inside soldering equipment *Temperature means The temperature of he PC board surface * PC board thickness for 1.0 mm *溫度指PC板表面的溫度 *PC板厚度为1.0毫米 The condition mentioned is temperature for lead-free soldering . 無鉛錫測試。 Alloy: Sn 96.5% Cu 3% Ag 0.5% 成份: 錫 96.5% 銅 3% 銀 0.5%	Without deformation of case or excessive looseness of teminals meet mechanical and electrical properties 本體無變形,能滿足於機械、電器性能.						

IT	TEM 項目	TEST CONDITION 測試條件	PERFORMAENCE 性能
9.4	LIFE TEST 壽命試驗	20,000 cycles of operation at a rate of 15-18 cycles per minute with unloading 無負載條件下,每分鐘 15-18 次的速度 操作20,000 次。	 (1) Contact resistance 50mΩ max. 接觸電阻50毫歐 以下 (2) force: 600gf max
9. 5	HEAT RESISTANT TEST 耐熱試驗	80±2℃ for 96 hours,test after keeping in normal condition for 30 minutes. 在 80±2℃ 環境中放96小時,再放在正常環境中30分鐘後進行測試。	 (1) Contact resistance 150 mΩ max. 接觸電阻150毫歐以下 (2) Insulation resistance 50 MΩ min. 絕緣電阻50兆歐以上 (3) There shall be no sign of mechanical and electrical damage.
9. 6	MOISTURE RESISTANT TEST 耐濕試驗	40±2℃ 90-95% RH for 96 hours,test after keeping in normal condition for 30 minutes. 在40±2℃ 90-95% RH 環境中放96小時,再放在正常環境中,30分鐘後進行測試。	
	COLD RESISTANT TEST 耐冷試驗	At -40±3℃ for 96 hours, test after keeping in mormal condition for 30minutes. 在 -40±3℃ 環境中放96小時,再置於正 常環境中,30分鐘後進行測試。	
9.8	TEMPERATURE CYCLING TEST 溫度交 變試驗	According to following figure,after 5 cycles, test after keeping in normal condition for 30 minutes. 如圖示之環境中,循環5次後,再置於正常環境中,30分鐘後進行測試。 +85℃ One cycle 1 2 1 Hours	
8. 9	STORAGE ENVIROMENT 儲存環境	Under sealing pack condition, stored temperature don't exceed 30℃ and relative humidity is 75% RH; in the enviroment of no sunshine direct and no corrosive gas, the stored time ought to be three months but within six month at most. 密封包裝狀態下,儲存溫度為≪30℃,相對溫度75% RH;,無陽光直射,無腐蝕性氣體的環境中,儲存時間為3個月,最長不宜超過6個月。Without sealing pack condition, stored temperature don't exceed 30℃ and relative humidity is 75% RH; in the enviroment of no sunshine direct and no corrosive gas, the stored time shouldn't exceed 168H 無密封包裝狀態下,儲存溫度為≪30℃,相對溫度75% RH;,無陽光直射,無腐蝕性氣體的環境中,儲存時間最長不宜超過168小時。Don't excessive overlap or overstocking when keeping this goods, in case of damage. 保存時應注意物品不能過量重疊、積壓、以免損壞	